

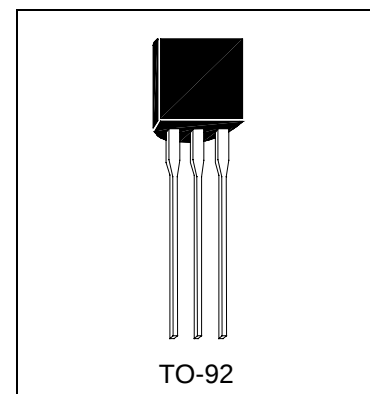


HE8051S

NPN EPITAXIAL PLANAR TRANSISTOR

Description

The HE8051S is designed for general purpose amplifier applications.



Absolute Maximum Ratings

- Maximum Temperatures
Storage Temperature -55 ~ +150 °C
Junction Temperature +150 °C Maximum
- Maximum Power Dissipation
Total Power Dissipation (Ta=25°C) 625 mW
- Maximum Voltages and Currents (Ta=25°C)
VCBO Collector to Base Voltage 25 V
VCEO Collector to Emitter Voltage 20 V
VEBO Emitter to Base Voltage 5 V
IC Collector Current 700 mA

Characteristics (Ta=25°C)

Symbol	Min.	Typ.	Max.	Unit	Test Conditions
BVCBO	25	-	-	V	IC=10uA
BVCEO	20	-	-	V	IC=1mA
BVEBO	5	-	-	V	IE=10uA
ICBO	-	-	1	uA	VCB=20V
IEBO	-	-	100	nA	VEB=6V
*VCE(sat)	-	-	0.5	V	IC=0.5A, IB=50mA
VBE(on)	-	-	1	V	VCE=1V, IC=150mA
*hFE1	100	-	500		VCE=1V, IC=150mA
*hFE2	-	140	-		VCE=1V, IC=500mA
fT	150	-	-	MHz	VCE=10V, IC=20mA, f=100MHz
Cob	-	-	10	pF	VCB=10V, f=1MHz, IE=0

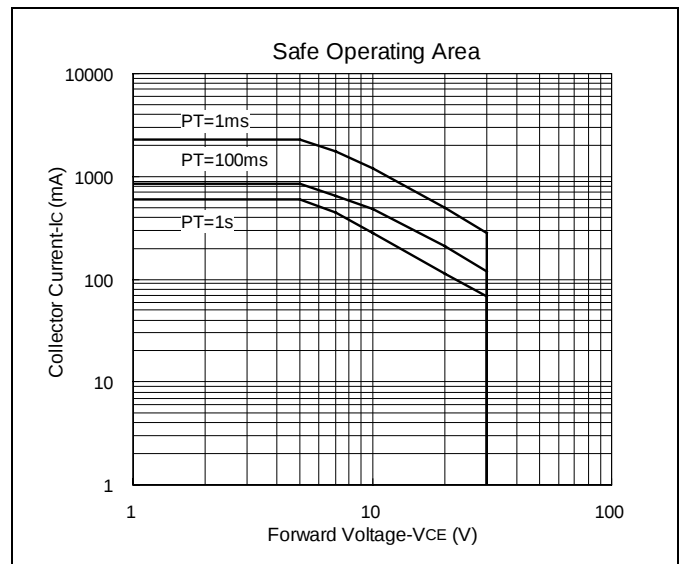
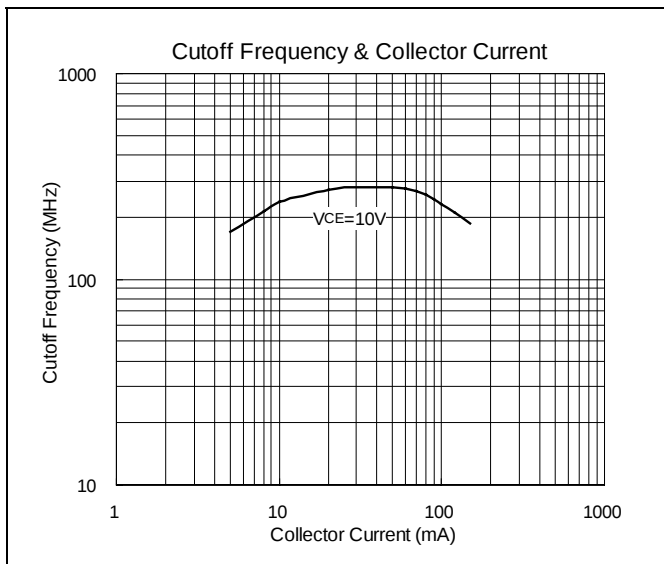
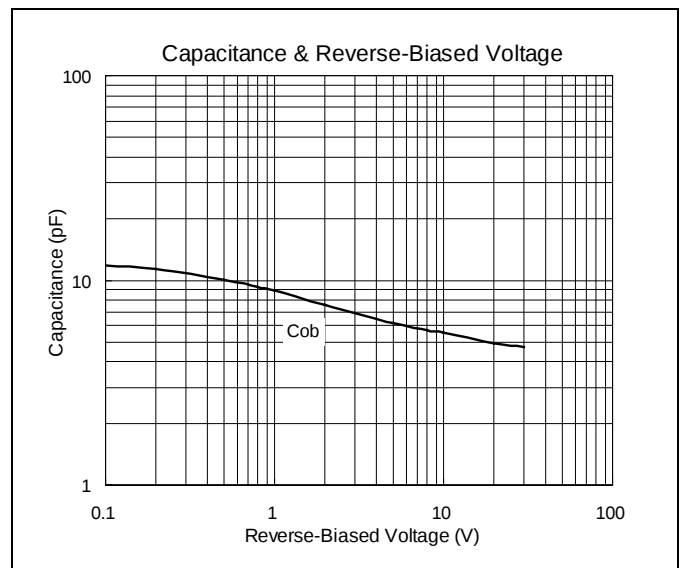
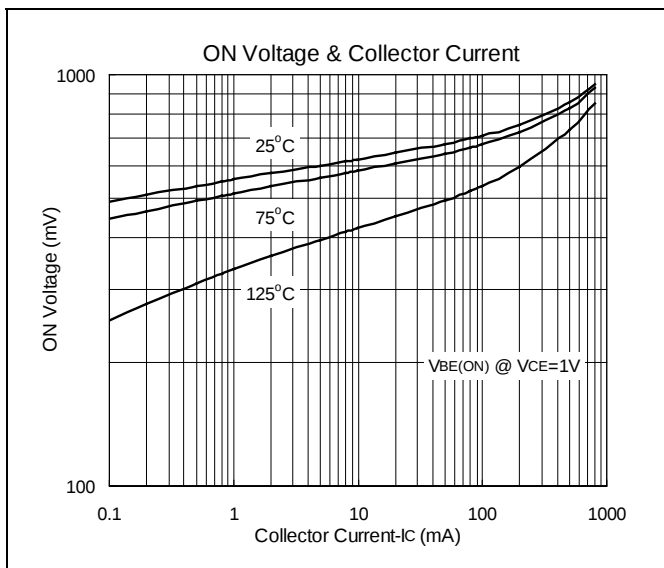
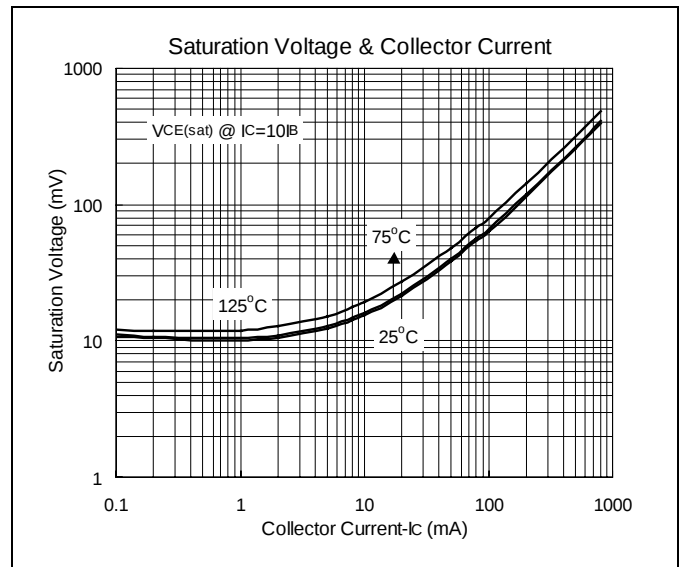
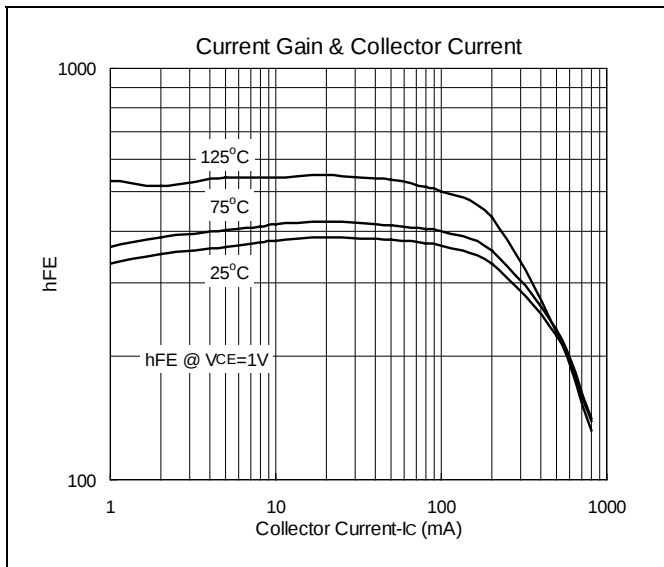
*Pulse Test: Pulse Width ≤380us, Duty Cycle≤2%

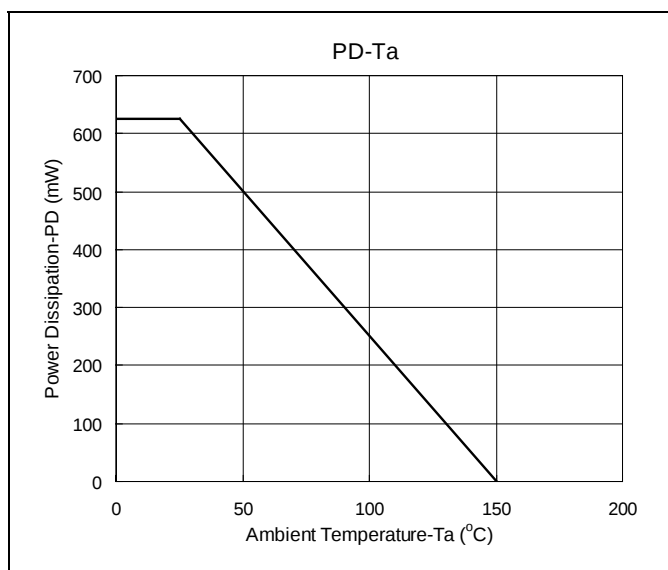
Classification Of hFE

Rank	C	C1	D	D1	E
hFE1	100-180	100-180	160-300	160-300	250-500
hFE2	-	>100	-	>100	-



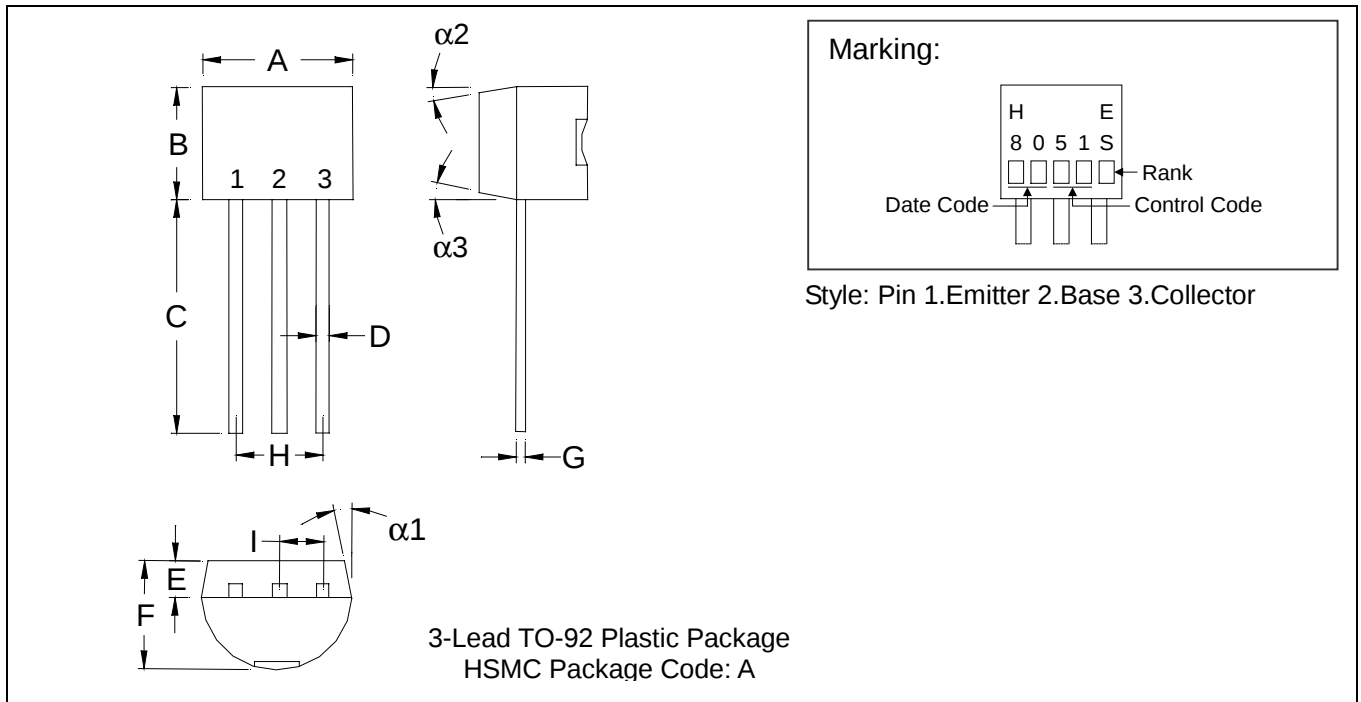
Characteristics Curve







TO-92 Dimension



*: Typical

DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	0.1704	0.1902	4.33	4.83	G	0.0142	0.0220	0.36	0.56
B	0.1704	0.1902	4.33	4.83	H	-	*0.1000	-	*2.54
C	0.5000	-	12.70	-	I	-	*0.0500	-	*1.27
D	0.0142	0.0220	0.36	0.56	$\alpha 1$	-	*5°	-	*5°
E	-	*0.0500	-	*1.27	$\alpha 2$	-	*2°	-	*2°
F	0.1323	0.1480	3.36	3.76	$\alpha 3$	-	*2°	-	*2°

Notes: 1.Dimension and tolerance based on our Spec. dated Apr. 25,1996.
2.Controlling dimension: millimeters.
3.Maximum lead thickness includes lead finish thickness, and minimum lead thickness is the minimum thickness of base material.
4.If there is any question with packing specification or packing method, please contact your local HSMC sales office.

Material:

- Lead: 42 Alloy; solder plating
- Mold Compound: Epoxy resin family, flammability solid burning class: UL94V-0

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